

SAW Filter datasheet

3.0 x 3.0 x 1.3 mm, SMD

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Features

Features

- 868.6 MHz center frequency
- Ceramic package for Surface Mounted Technology
- Low Loss: 2.6 dB typical value within PassBand Width 868 to 870 MHz
- Good rejections specially for the LTE band and the UMTS band
- Maximum pulse power: 27 dBm

Applications

- Remote control RF
- Wireless applications:
 - Home appliances
 - Security systems



3.0 x 3.0 x 1.3 mm

Maximum Ratings

Parameter	Min.	Тур.	Max.	Unit
Storage temperature range (T _{stg})	-40		85	°C
Operating temperature range (T _A)	-40		85	°C
DC permissive voltage			10	V
Maximum pulse input power			27	dBm
Maximum Input Power Handling (at 50°C during 50,000 hours)			20	dBm

Frequency and Electrical Characteristics (Reference temperature @ 25°C)

Parameter	Min.	Typ. ¹	Max.	Unit
Center frequency (fc)		868.6		MHz
Bandwidth (BW, passband width)	2.00			MHz
Insertion loss (IL, 868 – 870 MHz)		2.6	3.5	dB
Amplitude ripple (868 – 870 MHz)		0.3	1.8	dB
Absolute Attenuation				
From D.C to 300 MHz	40	45		
From 300 to 862.0 MHz	30	35		
From 862.0 to 863.0 MHz	15	20		dB
From 878 to 880.0 MHz	20	25		
From 880.0 to 1500 MHz	35	40		
Temperature coefficient of frequency		-31.0		ppm/K
Source impedance ² (Single ended)		50		Ω
Load impedance ² (Single ended)		50		Ω

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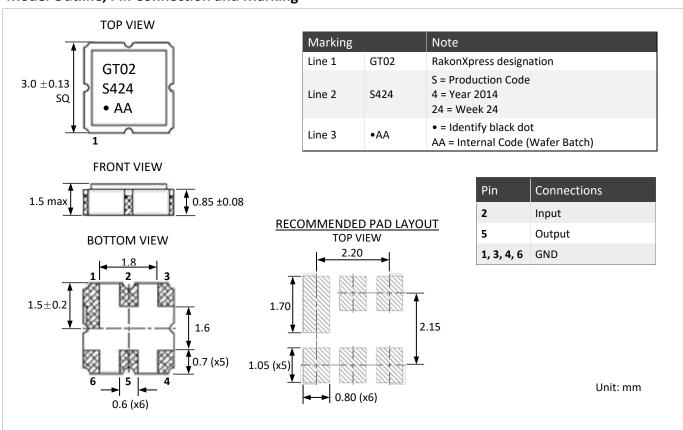
¹ Typical values are nominal performances at room temperature

² No external matching is required

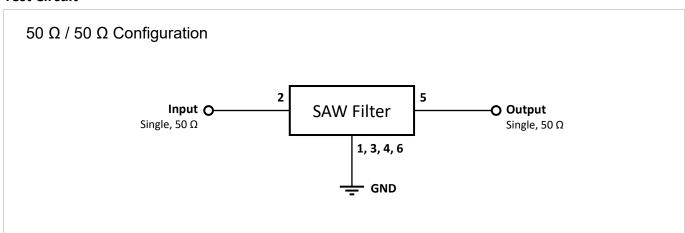




Model Outline, Pin Connection and Marking



Test Circuit

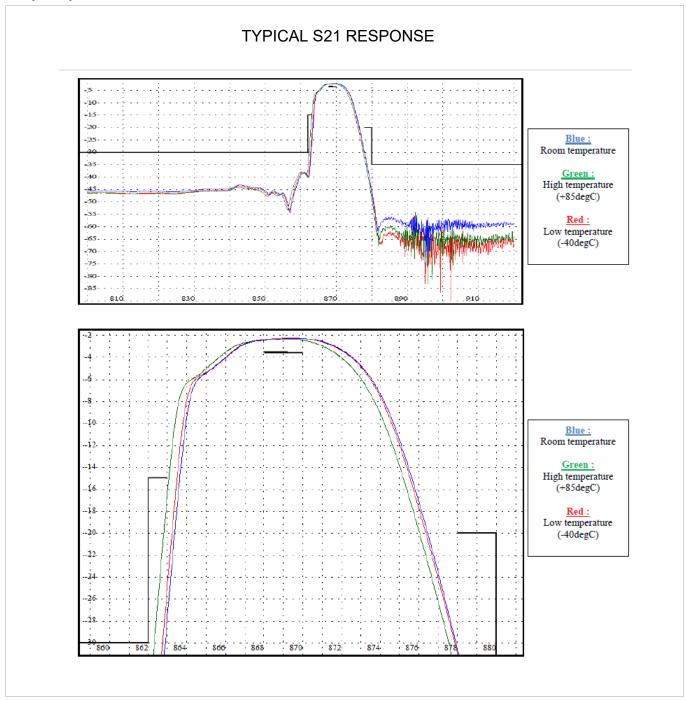


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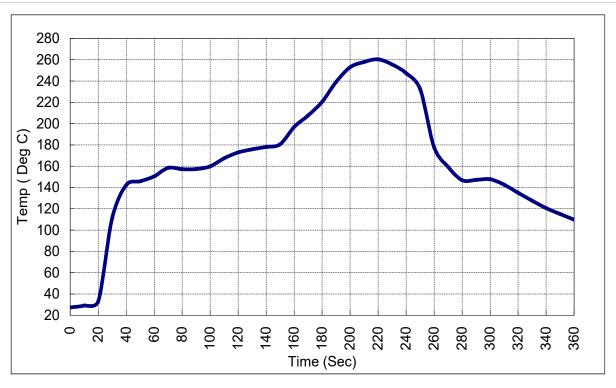
Frequency Characteristics



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Recommended Reflow Soldering Profile



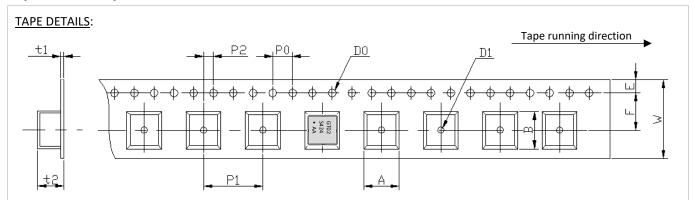
NOTE:

- The components shall remain within the electrical specifications after it soldered on the 1mm thickness PCB board and dipped in the solder at 260 ± 5°C during 10 ± 1 seconds.
- The components shall remain within the electrical specifications after it soldered by electric iron, solder at 350 ± 10 °C during 3~4 seconds. Recovery time: 2 ± 0.5 hour.
- Ultrasonic cleaning may cause deterioration and destruction of the component. Please avoid ultrasonic cleaning.
- Only leads of components may be soldered. Please avoid soldering another part of the component.

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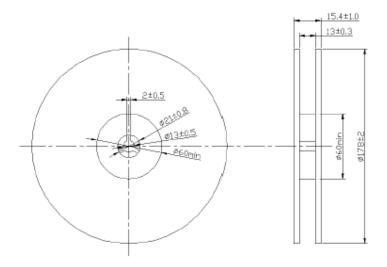


Tape and Reel Specifications



Parameter	Code	Dimension	Tolerance
Height of component hole	Α	3.3 max	
Width of component hole	В	3.3 max	
Diameter of sprocket hole	D ₀	Ф 1.5	± 0.1
Diameter of feed hole	D ₁	Ф 1.5	± 0.25
Pitch of sprocket hole	P ₀	4.0	± 0.2
Length from hole center to component center	P ₁	4.0	± 0.1
Length from Pocket hole center to sprocket hole center	P ₂	2.0	± 0.2
Width of carrier tape	W	12.0	± 0.3
Width of adhesive tape	F	5.5	± 0.3
Gap of hold down tape and carrier tape	E	1.75	± 0.1
Thickness of Ebossed tape sheet	t1	0.31 max	
Thickness of Ebossed tape	t2	1.7 max	

REEL DETAILS:



NOTE:

- Unit: mm
- Standard Packing Quantity (SPQ) is 3000 pieces/ reel

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Reliability Test

Parameter	Test condition / Description
Thermal Shock	The components shall remain within the electrical specifications after being kept at the condition of heat cycle conditions: TA=-40 $^{\circ}$ C $\pm 3^{\circ}$ C, TB=85 $^{\circ}$ C $\pm 2^{\circ}$ C, t1=t2=30min, switch time \leq 3min & cycle time: 100 times, recovery time: 2h \pm 0.5h.
Temperature Storage	High Temperature Storage: The components shall remain within the electrical specifications after being kept at the 85°C ±2°C for 500 hours, recovery time: 2h ±0.5h. Low Temperature Storage: The components shall remain within the electrical specifications after being kept at the -40°C ±3°C for 500 hours, recovery time: 2h ±0.5h.
Humidity test	The components shall remain within the electrical specifications after being kept at the condition of ambient temperature 60°C ±2°C, and 90~95% RH for 500 hours.
Drop test	The components shall remain within the electrical specifications after random free drops 10 times from height of 1.0 meter onto concrete floor, and the specimens shall meet the electrical specifications.
Vibration Fatigue	The components shall remain within the electrical specifications after loaded vibration at 10~55Hz, amplitude 1.5mm, X, Y, Z, direction, during 2 hours.
Mechanical Shock	The components shall remain within the electrical specifications after 1000 shocks, acceleration 392 m/s 2 , duration 6ms.
Note	As a result of the particularity of inner structure of SAW products, the components can easily be breakdown by electrostatic shock; so it's mandatory to pay attention to ESD protect during the tests.